

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

NPN Epitaxial Planar Silicon Transistor

15C01M — Low-Frequency General-Purpose Amplifier Applications

Applications

· Low-frequency Amplifier, muting circuit

Features

- · Large current capacity
- · Low collector-to-emitter saturation voltage (resistance) RCE (sat) typ.=0.58Ω [IC=0.7A, IB=35mA]
- · Ultrasmall package facilitates miniaturization in end products
- · Small ON-resistance (Ron)

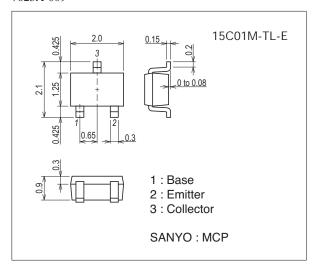
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		20	V
Collector-to-Emitter Voltage	VCEO		15	V
Emitter-to-Base Voltage	V _{EBO}		5	V
Collector Current	IC		700	mA
Collector Current (Pulse)	ICP		1.4	Α
Collector Dissipation	PC	Mounted on a glass epoxy board (20×30×1.6mm)	300	mW
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ) 7023A-009

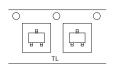


Product & Package Information

• Package : MCP

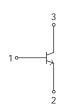
• JEITA, JEDEC : SC-70, SOT-323 • Minimum Packing Quantity : 3,000 pcs./reel

Packing Type: TL Marking





Electrical Connection

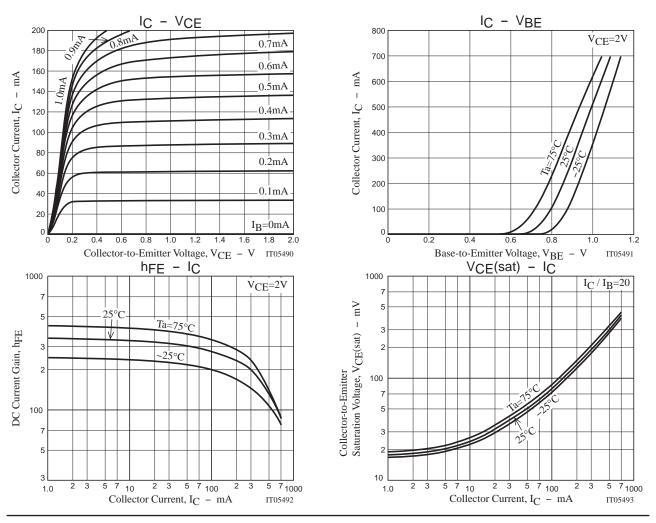


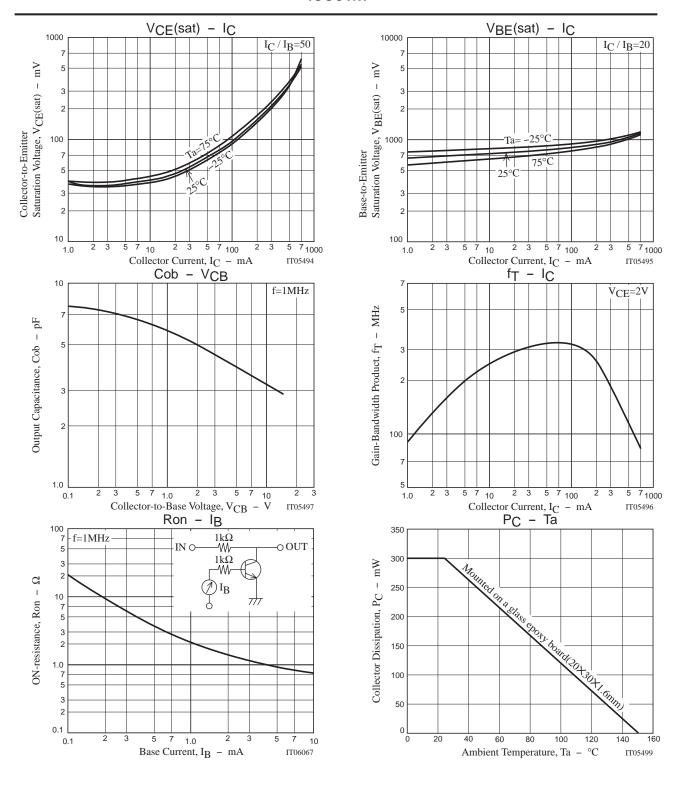
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Linit	
Parameter	Symbol Conditions		min	typ	max	Unit	
Collector Cutoff Current	ICBO	V _{CB} =15V, I _E =0A			0.1	μΑ	
Emitter Cutoff Current	IEBO	V _{EB} =4V, I _C =0A			0.1	μΑ	
DC Current Gain	hFE	V _{CE} =2V, I _C =10mA	300		800		
Gain-Bandwidth Product	fT	V _{CE} =2V, I _C =50mA		330		MHz	
Output Capacitance	Cob	V _{CB} =10V, f=1MHz		3.2		pF	
Collector-to-Emitter Saturation Voltage	V _{CE} (sat)	I _C =200mA, I _B =10mA		150	300	mV	
Base-to-Emitter Saturation Voltage	V _{BE} (sat)	I _C =200mA, I _B =10mA		0.9	1.2	V	
Collector-to-Base Breakdown Voltage	V(BR)CBO	I _C =10μA, I _E =0A	20			V	
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=1mA, RBE=∞	15			V	
Emitter-to-Base Breakdown Voltage	V(BR)EBO	I _E =10μA, I _C =0A	5			V	
Turn-On Time	ton			30		ns	
Storage Time	t _{stg}	See specified Test Circuit.		77		ns	
Fall Time	tf			40		ns	

Ordering Information

Device	Package	Shipping	memo	
15C01M-TL-E			Pb Free	



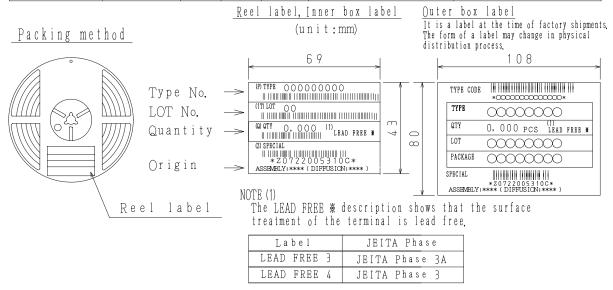


Embossed Taping Specification

15C01M-TL-E

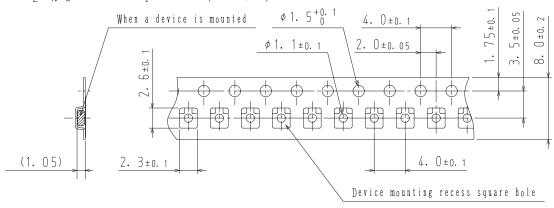
1. Packing Format

Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	format
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCP	MCP	3, 000	15, 000	90,000	5 reels contained	6 inner boxes contained
					Dimensions:mm (external)	Dimensions:mm (external)
					183×72×185	440×195×210

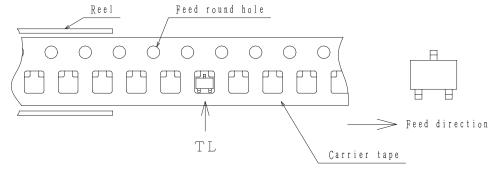


2. Taping configuration

2-1. Carrier tape size (unit:mm)



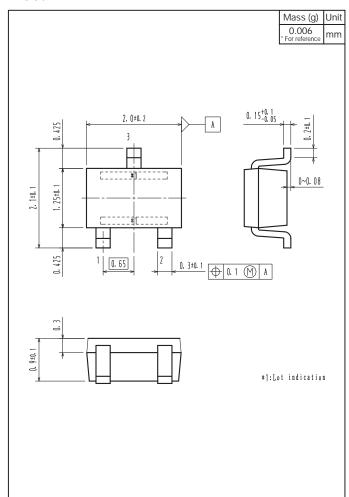
2-2. Device placement direction



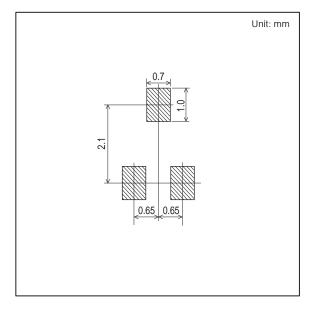
Those with oen electrode terminal on the feed hole side·····TL

Outline Drawing

15C01M-TL-E



Land Pattern Example



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